TOSHIBA PHOTOCOUPLER PHOTO RELAY

TLP3230

Measuring Instruments Logic IC Testers / Memory Testers Board Testers / Scanners

The TOSHIBA TLP3230 is an ultra-small photorelay suitable for surface-mount assembly. The TLP3230 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOSFET and is housed in a 4-pin package.

Its features include low Off-state current and low output pin capacitance, enabling it to be used for high-frequency measuring instrument applications.

Features

- 4-pin SSOP (SSOP4): 1.8-mm high, 1.27-mm pitch
- 1-Form-A

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- Peak Off-State Voltage: 20 V (min)
- Trigger LED Current: 4 mA (max)
- On-State Current: 160 mA (max)
- On-State Resistance: 8 Ω (max), 5 Ω (typ.)
- Output Capacitance: 2.5 pF (max), 1.0 pF (typ.)

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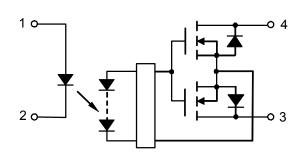
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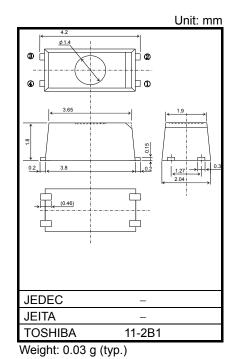
• Isolation Voltage: 1500 Vrms (min)

Pin Configuration (Top View)

1 : ANODE 2 : CATHODE 3 : DRAIN 4 : DRAIN







Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	lF	50	mA
Ģ	Forward Current Derating (Ta $\ge 25^{\circ}$ C)	∆l _F /°C	-0.5	mA/°C
LED	Reverse Voltage	V _R	5	V
	Junction Temperature	Tj	125	°C
ц	Off-State Output Terminal Voltage	V _{OFF}	20	V
DETECTOR	On-State Current	I _{ON}	160	mA
ETE(On-State Current Derating (Ta \ge 25°C)	∆l _{ON} /°C	-1.6	mA/°C
	Junction Temperature		125	°C
Storage Temperature Range		T _{stg}	-40 to 125	°C
Operating Temperature Range		T _{opr}	-20 to 85	°C
Lead	Soldering Temperature (10 s)	T _{sol}	260	°C
Isola	tion Voltage (AC, 1 minute, R.H. \leq 60%) (Note 1)	BVS	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: Pins 1 and, 2 shorted together, and pins 3 and 4 shorted together.

Caution

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

Recommended Operating Conditions

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	V _{DD}	_	_	20	V
Forward Current	١ _F	_	_	30	mA
On-State Current	I _{ON}	_	_	160	mA
Operating Temperature	T _{opr}	-20		65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Forward Voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
Ē	Reverse Current	I _R	$V_R = 5 V$	—	_	10	μA
	Capacitance	CT	V = 0, f = 1 MHz	_	15	_	pF
CTOR	Off-State Current	IOFF	V _{OFF} = 20 V, Ta = 50°C	_	_	1000	pА
DETEC	Capacitance	C _{OFF}	V = 0, f = 100 MHz, t < 1 s	_	1.0	2.5	pF

Coupled Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Trigger LED Current	I _{FT}	I _{ON} = 100 mA	_	_	4	mA
Return LED Current	I _{FC}	I _{OFF} = 10 μA	0.2	0.75	_	mA
On-State Resistance	R _{ON}	I _{ON} = 160 mA, I _F = 5 mA, t < 1 s		5	8	Ω

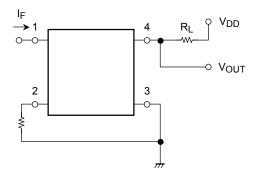
Isolation Characteristics (Ta = 25°C)

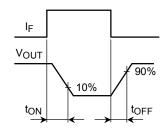
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Capacitance Input to Output	CS	$V_{S} = 0 V$, f = 1 MHz	_	0.3	_	pF
Isolation Resistance	R _S	$V_S = 500 \text{ V}, \text{ R.H.} \le 60\%$	$5 imes 10^{10}$	10 ¹⁴	_	Ω
	BVS	AC, 1 minute	1500	_	_	Vrms
Isolation Voltage		AC, 1 second (in oil)		3000	_	VIIIIS
		DC, 1 minute (in oil)	—	3000		Vdc

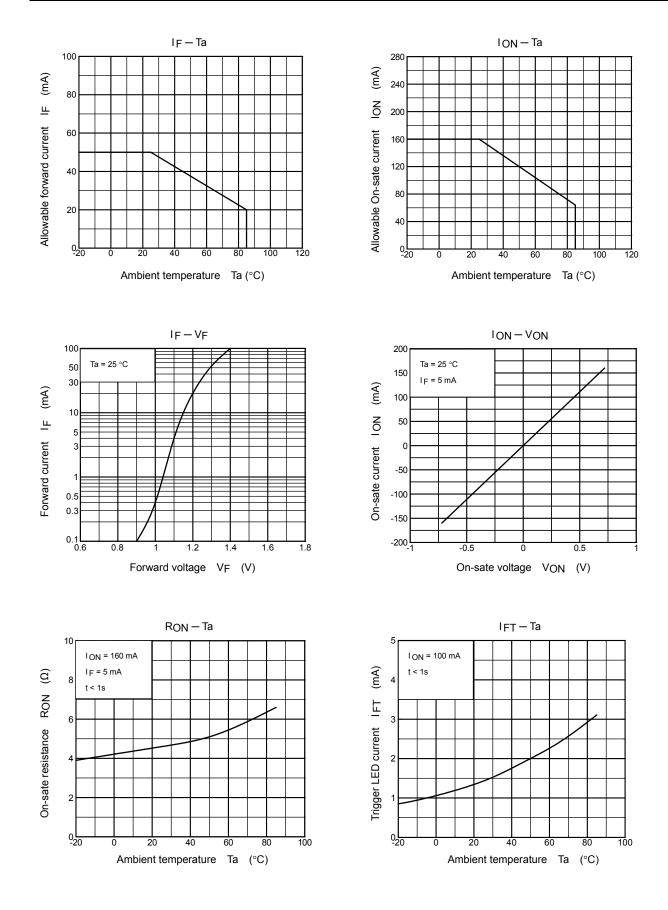
Switching Characteristics (Ta = 25°C)

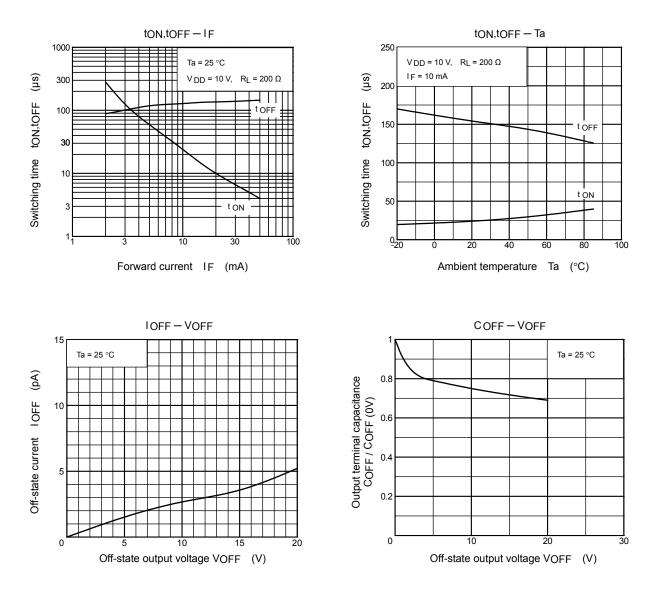
CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN	TYP.	MAX	UNIT
Turn-on Time	t _{ON}	$R_L = 200 \Omega$ (Note	(Note)	-	60	500	
Turn-off Time	tOFF	V _{DD} = 10 V, I _F = 5 mA		—	120	500	μS

Note: SWITCHING TIME TEST CIRCUIT

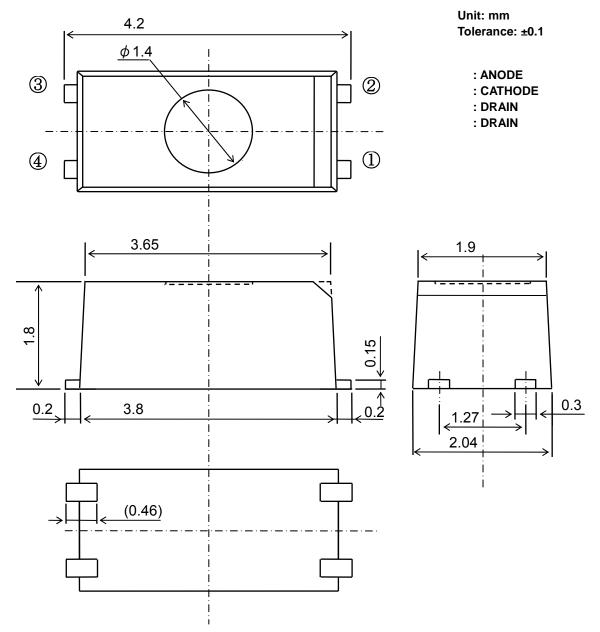








Package Dimensions



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